

PRODUCT/PROCESS CHANGE NOTICE (PCN)

		· /		
PCN #: A0702-01 DATE: 22-M	ar-2007 MEANS OF DISTING	UISHING CHANGED DEVICES:		
Product Affected: 24.5mm x 19.5mm FCBGA-655 Refer to attachment II for the	Product MarkBack Mark	Assembly lot marked on the		
affected part numbers.	□ Date Code	device provides traceability to the mold compound type		
Date Effective: 22-Jun-2007	Other			
Contact: Geoffrey Cortes	-			
Title: Product Quality	Attachment:	Yes No		
Phone #: (408) 284-8321				
Fax #: (408) 284-1450	1	act your local sales representative for lest & availability.		
E-mail: <u>Geoffrey.Cortes@idt.com</u>	sample requ			
DESCRIPTION AND PURPOSE OF CHANGE:				
□ Die Technology □ Wafer Fabrication Process This notificat	ion is to advise our customers that	t IDT is converting underfill		
	Sumitomo 4152RA to Namics U	-		
□ Equipment qualification.	There is no change to the moistu	re performance of these packages.		
Material	ashmont for malification data	d offected part number list		
□ Testing Please see atta □ Manufacturing Site	achment for qualification data and	u anecieu part number list.		
□ Data Sheet				
□ Other				
RELIABILITY/QUALIFICATION SUMMARY:				
There is no impact with regards to the package performan	nce or reliability.			
CUSTOMER ACKNOWLEDGMENT OF RECEIPT	:			
IDT records indicate that you require written notification		knowledgement below or E-Mail		
to grant approval or request additional information. If ID	-	-		
it will be assumed that this change is acceptable.				
IDT reserves the right to ship either version manufactured after the process change effective date until the inventory				
on the earlier version has been depleted.				
Customer:	□ Approval for sh	ipments prior to effective date.		
Name/Date:	E-Mail Address:			
Title:	Phone# /Fax# :			
CUSTOMER COMMENTS:				
IDT ACKNOWLEDGMENT OF RECEIPT:				
RECD. BY:	DATE:			
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ATTACHMENT I - PCN #: A0702-01

PCN Type:	Assembly Material Change
Data Sheet Change:	None
Detail Of Change:	This notification is to advise our customers that IDT is converting underfill material from Sumitomo 4152RA to Namics U8437-2 after successful qualification.
	There is no change in the moisture sensitivity level (MSL).
	Please see attachment I for qualification data and attachment II for affected part number list.

Description	Affected Package Types	Material		
Description		Old	New	
Underfill Material	24.5mm x 19.5mm FCBGA- 655	Sumitomo 4152RA	Namics U8437-2	

Sample Availability: Samples are not built ahead of the change and are limited to selective devices. Please contact your local IDT sales representative for sample request and availability.



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ATTACHMENT I - PCN #: A0702-01

Qualification Plan #: P06-06-05R1

Test Vehicle: 24.5mm x 19.5mm FCBGA-655 (1 lot)

Qualification Test Plan and Results:

Test Description	Test Method (Latest specs in effect)	Number of Lot	Test Results (SS/Rej)
* Temperature Cycling (Cond B, 1000 cycles)	JESD22-A104	1	45/0
* Unbiased HAST (130°C, 85% RH, 100 hours)	JESD22-A118	1	45/0
High Temperature Stabilization Bake (150 °C, 1000 hours)	JESD22-A103	1	77/0
Moisture Sensitivity Classification, L4	J-STD-020	1	45/0

Note: * Test require moisture pre-conditioning sequence per JESD22-A113.



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ATTACHMENT II - PCN #: A0702-01

Affected Part Number

IDT Part Number	IDT Part Number	IDT Part Number	IDT Part Number
IDTAMB0480A3RH	IDTAMB0480ARH	IDTAMB0481A0RH	IDTAMB0482C1RH
IDTAMB0480A3RJ	IDTAMB0480ARJ	IDTAMB0481A0RJ	IDTAMB0482C1RJ
IDTAMB0480A5RH	IDTAMB0480B1RH	IDTAMB0481A1RJ	
IDTAMB0480A5RJ	IDTAMB0480B1RJ	IDTAMB0482C0RJ	

Notes: For T & R (shipping method) "8" is added to the p/n.